



To the Director of the U.S. Patents and Trademark

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inal documents or copy thereof.

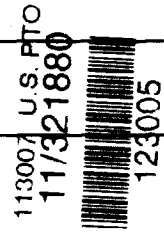
12-30-05

1. **Name of conveying party(ies):**
1) Kazushige OHNO
2) Masafumi KUNIEDA
3) Kazutake OGYU
Additional name(s) of conveying party(ies) attached? Yes No

2. **Name and address of receiving party(ies):**
Name: IBIDEN CO., LTD.
Internal Address:

3. **Nature of conveyance/Execution Date(s):**
Execution Dates December 20, 2005
 Assignment Merger
 Security Agreement Change of Name
 Joint Research Agreement
 Government Interest Assignment
 Executive Order 9424, Confirmatory License
 Other

Street Address: 1, Kandacho 2-chome, Ogaki-Shi, Gifu
503-8604 Japan
City:
State: Zip Code:
Additional name(s) & Address(es) attached?
 Yes No



4. **Application number(s) or patent number(s):**
A. Patent Application Number(s):
Additional numbers attached? Yes No

This document is being filed together with a new application.
B. Patent Number(s):
 Yes No

5. **Name and address of to whom correspondence concerning document should be mailed:**
Name: Mr. Ernest F. Chapman
Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.
Street Address: 901 New York Avenue, NW
City: Washington, D.C.
State: Zip: 20001-4413

6. **Total number of applications and registrations involved:** 1
7. **Total fee (37 CFR 3.41): \$40**
 Authorized to be charged by credit card
 Authorized to be charged to deposit account
 Enclosed (Please charge deficiency to deposit account)
 None required (government interest not affecting title)
8. **Payment Information**
a. Credit Card Last 4 Numbers _____
Expiration Date _____
b. Deposit Account No.: 06-0916
Authorized User Name _____

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04 FC:8021 40.00 DP

8. **Statement and signature.**
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.
David W. Hill
Reg. No. 28,220

Signature
December 30, 2005
Date

Total number of pages including cover sheet, attachments and documents: 3

JOINT INVENTION
(U.S. Rights Only)

ASSIGNMENT

WHEREAS, We, the below named inventors, (hereinafter referred to as assignors, have made an invention entitled:

HONEYCOMB STRUCTURE

for which we executed an application for United States Letters Patent concurrently herewith or on or filed an application for United States Letters Patent on (Application No. _____); and

WHEREAS, IBIDEN CO., LTD., a corporation of Japan a corporation of Japan, whose post office address is 1, Kandacho 2-Chome, Ogaki-Shi, Gifu 503-8604 Japan (hereinafter referred to as assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, we, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and we hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY further covenant and agree that we will, without further consideration, communicate with assignee, its successors and assigns, any facts known to us respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, WE HEREBY authorize and request the attorneys we have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. _____, filed _____) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, we have hereunto set our hands.

First Assignor

Kazushige Ohno
c/o IBIDEN CO., LTD.,
Ogakikita Kojo, 1-1, Kitagata, Ibigawa-Cho, Ibi-Gun, Gifu
501-0695 Japan

Citizenship: Japan

Signature: Kazushige OHNO

Date: December 20, 2005

Second Assignor

Masafumi Kunieda
c/o IBIDEN CO., LTD.,
Ogakikita Kojo, 1-1, Kitagata, Ibigawa-Cho, Ibi-Gun, Gifu
501-0695 Japan

Citizenship: Japan

Signature: Masafumi Kunieda

Date: December 20, 2005

Third Assignor

Kazutake Ogyu
c/o IBIDEN CO., LTD.,
Ogakikita Kojo, 1-1, Kitagata, Ibigawa-Cho, Ibi-Gun, Gifu
501-0695 Japan

Citizenship: Japan

Signature: Kazutake Ogyu.

Date: December 20, 2005